Unit: mm

TOSHIBA Field Effect Transistor Silicon N Channel MOS Type

SSM3K44MFV

High Speed Switching Applications Analog Switch Applications

• AEC-Q101 qualified (Note 1)

Note:

· Compact package suitable for high-density mounting

• Low ON-resistance : RDS(ON) = 4.0 Ω (max) (@VGS = 4 V)

: RDS(ON) = 7.0 Ω (max) (@VGS = 2.5 V)

Note 1: For detail information, please contact to our sales.

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Drain-source voltage		VDSS	30	V	
Gate-source voltage		Vgss	±20	V	
Drain current	DC	ΙD	100	mA	
	Pulse	I _{DP}	200		
Drain power dissipation (Ta = 25°C)		P _D (Note 1)	150	mW	
Channel temperature		T _{ch}	150	°C	
Storage temperature		T _{stg}	-55 to 150	°C	

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

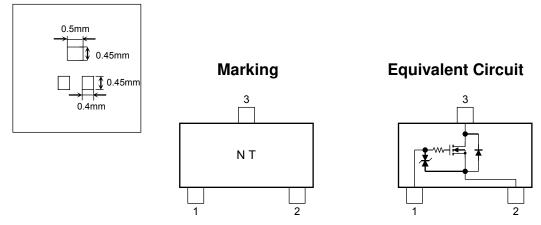
1.2±0.05
0.8±0.05
0.8±0.05
0.8±0.05
1. Gate
2. Source
VESM 3. Drain

JEDEC —
JEITA —
TOSHIBA 2-1L1B

Weight: 1.5 mg (typ.)

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Total rating, mounted on FR4 board (25.4 mm \times 25.4 mm \times 1.6 mm)



Handling Precaution

When handling individual devices (which are not yet mounted on a circuit board), be sure that the environment is protected against electrostatic electricity. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

Start of commercial production 2009-12

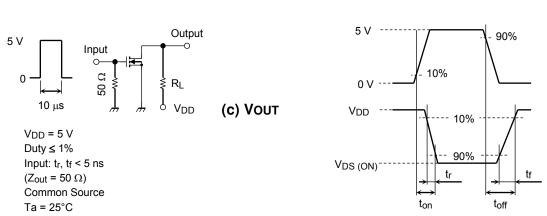
Electrical Characteristics (Ta = 25°C)

Chara	Characteristics Symbol Test Condition		Test Condition	Min	Тур.	Max	Unit	
Gate leakage current		IGSS	$V_{GS} = \pm 14 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±1	μΑ	
Drain-source breakdown voltage		V (BR) DSS	I _D = 0.1 mA, V _G S = 0 V	30	_	_	V	
Drain cut-off curre	nt	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V	_	_	1	μА	
Gate threshold vo	Itage	V _{th}	V _{DS} = 3 V, I _D = 0.1 mA	0.8	_	1.5	V	
Forward transfer a	admittance	Yfs	V _{DS} = 3 V, I _D = 10 mA	25	_	_	mS	
Drain-Source on-resistance		RDS (ON)	I _D = 10 mA, V _G S = 4 V	_	2.2	4.0		
			I _D = 10 mA, V _{GS} = 2.5 V	_	4.0	7.0	Ω	
Input capacitance Reverse transfer capacitance		C _{iss}	V _{DS} = 3 V, V _{GS} = 0 V, f = 1 MHz	_	8.5	_	pF	
		Crss		_	5.3	_		
Output capacitance		Coss		_	9.4	_		
Switching time	Turn-on time	ton	V _{DD} = 5 V, I _D = 10 mA, V _{GS} = 0 to 5 V	_	50	_	ns	
	Turn-off time	t _{off}			200	_		

Switching Time Test Circuit



(b) VIN

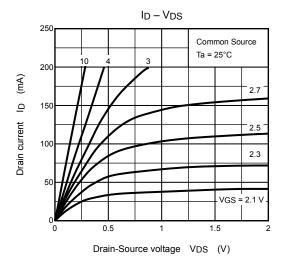


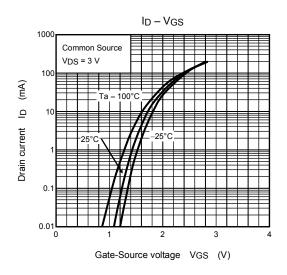
Precaution

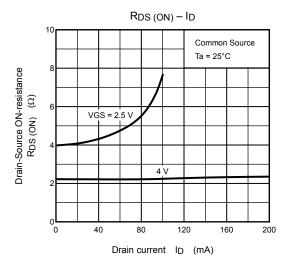
 V_{th} can be expressed as the voltage between gate and source when the low operating current value is ID = 100 μ A for this product. For normal switching operation, VGS (on) requires a higher voltage than V_{th} and VGS (off) requires a lower voltage than V_{th} .

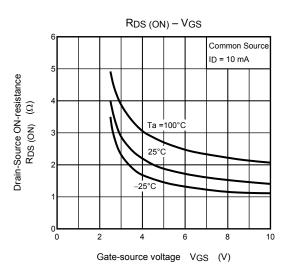
(The relationship can be established as follows: VGS (off) $\leq Vth \leq VGS$ (on))

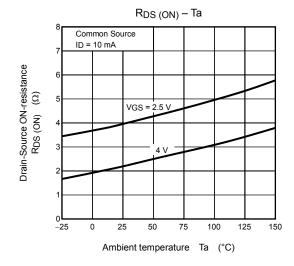
Please take this into consideration when using the device.

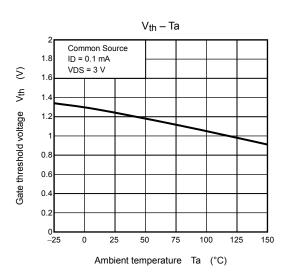


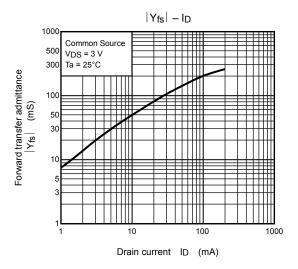


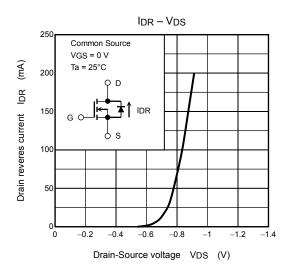


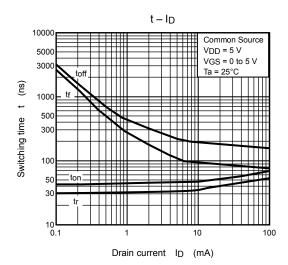


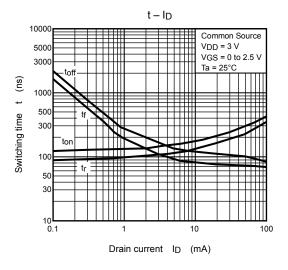


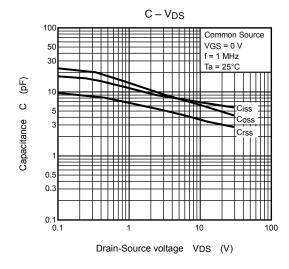


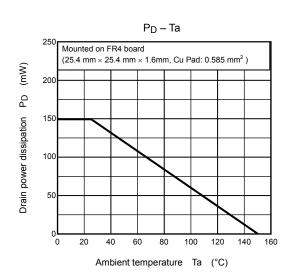












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